



Attorney Docket No. 42390P10075

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Patent Application of:

Harry Q. Pon

Application No.: 09/822,944

Filed: March 30, 2001

For: INSULATED BOND WIRE ASSEMBLY
PROCESS TECHNOLOGY FOR
INTEGRATED CIRCUITS

Examiner: Andujar, L.

Art Unit: 2826

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Sir:

In response to the Office Action mailed March 10, 2003, please amend the above-identified application as follows.

I hereby state that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450 on

August 11, 2003

CATNY A. KERK

Name of Person Mailing Correspondence

Name of Person Mailing Correspondence
Cathy A. Keri August 11, 2003
Signature Date

Signature

Date _____

RECEIVED
AUG 18 2003
TECHNOLOGY CENTER 2800